October 2004

ISL9V3040D3S / ISL9V3040S3S / ISL9V3040P3 / ISL9V3040S3

EcoSPARK[™] 300mJ, 400V, N-Channel Ignition IGBT

General Description

The ISL9V3040D3S, ISL9V3040S3S, ISL9V3040P3, and ISL9V3040S3 are the next generation ignition IGBTs that offer outstanding SCIS capability in the space saving D-Pak (TO-252), as well as the industry standard D²-Pak (TO-263), and TO-262 and TO-220 plastic packages. This device is intended for use in automotive ignition circuits, specifically as a coil driver. Internal diodes provide voltage clamping without the need for external components.

EcoSPARK[™] devices can be custom made to specific clamp voltages. Contact your nearest Fairchild sales office for more information.

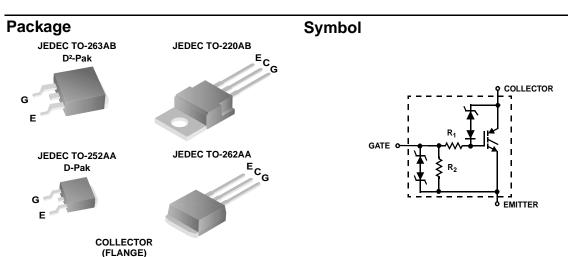
Formerly Developmental Type 49362

Applications

- Automotive Ignition Coil Driver Circuits
- Coil- On Plug Applications

Features

- Space saving D-Pak package availability
- SCIS Energy = 300mJ at T₁ = 25° C
- Logic Level Gate Drive



Device Maximum Ratings T_A = 25°C unless otherwise noted

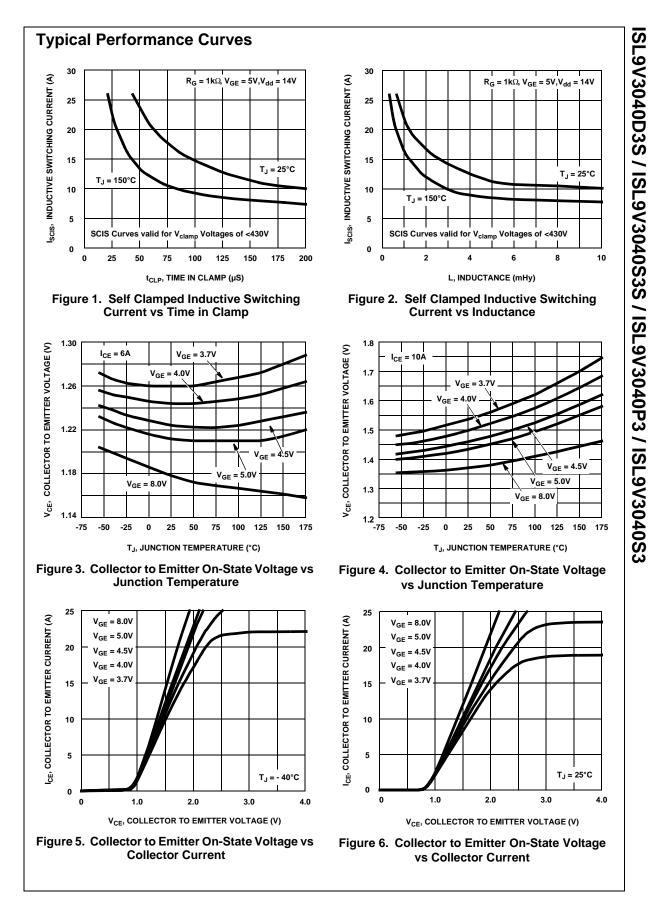
Symbol	Parameter	Ratings	Units	
BV _{CER}	BV _{CER} Collector to Emitter Breakdown Voltage (I _C = 1 mA)		V	
BV _{ECS}	Emitter to Collector Voltage - Reverse Battery Condition (I _C = 10 mA)	24	V	
E _{SCIS25}	At Starting $T_J = 25^{\circ}$ C, $I_{SCIS} = 14.2$ A, L = 3.0 mHy	300	mJ	
E _{SCIS150}			mJ	
I_{C25} Collector Current Continuous, At T_{C} = 25°C, See Fig 9		21	Α	
I_{C110} Collector Current Continuous, At $T_{C} = 110^{\circ}$ C, See Fig 9		17	Α	
V _{GEM}	Gate to Emitter Voltage Continuous	±10	V	
PD	Power Dissipation Total $T_C = 25^{\circ}C$	150	W	
	Power Dissipation Derating $T_{C} > 25^{\circ}C$	1.0	W/°C	
TJ	Operating Junction Temperature Range	-40 to 175		
T _{STG}	Storage Junction Temperature Range	-40 to 175	°C	
T _L Max Lead Temp for Soldering (Leads at 1.6mm from Case for 10s)		300	°C	
T _{pkg} Max Lead Temp for Soldering (Package Body for 10s)		260	°C	
ESD Electrostatic Discharge Voltage at 100pF, 1500Ω		4	kV	

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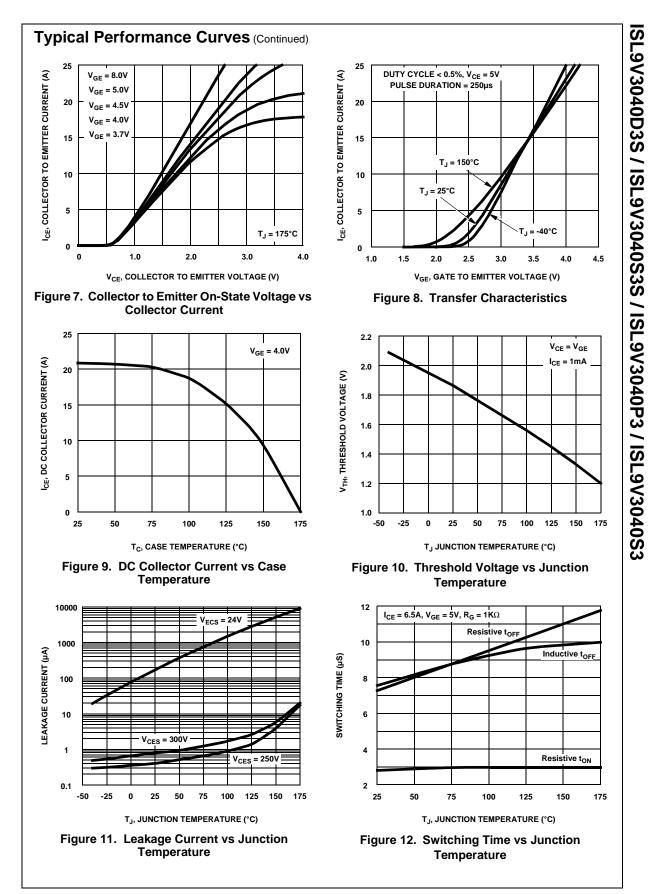
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Device M	arking	Device	P	Package	Reel Size	Таре	e Width	Qu	antity
V304	V3040D ISL9V3040D3ST T		T	O-252AA 330mm		16mm		2500	
		T	O-263AB 330mm		24mm		800		
V3040P ISL9V3040P3 T		O-220AA Tube		N/A		50			
		O-262AA Tube		N/A		50			
		O-252AA Tube		N/A		75			
V304		ISL9V3040S3S	1	D-263AB	Tube		N/A		50
		racteristics T _A = 25	5°C un			N 4:	True	Max	Unite
Symbol f State (Charact	Parameter		Test Cor	altions	Min	Тур	Max	Units
BV _{CER}	Characteristics Collector to Emitter Breakdown Voltage		$I_{C} = 2mA, V_{GE} = 0,$ $R_{G} = 1K\Omega$, See Fig. 15 $T_{J} = -40$ to 150°C		370	400	430	V	
BV _{CES}	Collector	Collector to Emitter Breakdown Voltage		$I_{C} = 10$ mA, $V_{GE} = 0$, $R_{G} = 0$, See Fig. 15 $T_{J} = -40$ to 150°C		390	420	450	V
BV _{ECS}	Emitter t	o Collector Breakdown Vo	ltage	$I_{C} = -75$ mA, $V_{GE} = 0$ V, $T_{C} = 25$ °C		30	-	-	V
BV _{GES}	Gate to	Emitter Breakdown Voltage	e	$I_{GES} = \pm 2mA$		±12	±14	-	V
I _{CER}	Collector	to Emitter Leakage Curre	ent	V _{CER} = 250V,	T _C = 25°C	-	-	25	μA
				R _G = 1KΩ, See Fig. 11	T _C = 150°C	-	-	1	mA
I _{ECS}	Emitter t	o Collector Leakage Curre	ent	$V_{EC} = 24V$, See		-	-	1	mA
				Fig. 11	T _C = 150°C	-	-	40	mA
R ₁		s Gate Resistance				-	70	-	Ω
R ₂	Gate to I	Emitter Resistance				10K	-	26K	Ω
n State (Charact	eristics							
CE(SAT)	Collector	lector to Emitter Saturation Voltage		I _C = 6A, V _{GE} = 4V	T _C = 25°C, See Fig. 3	-	1.25	1.60	V
CE(SAT)	Collector	lector to Emitter Saturation Voltage		I _C = 10A, V _{GE} = 4.5V	T _C = 150°C, See Fig. 4	-	1.58	1.80	V
CE(SAT)	Collector	ctor to Emitter Saturation Voltage		I _C = 15A, V _{GE} = 4.5V	T _C = 150°C	-	1.90	2.20	V
namic	Charact	eristics							
Q _{G(ON)}	Gate Ch	Gate Charge		I _C = 10A, V _{CE} = V _{GE} = 5V, See	= 12V, Fig. 14	-	17	-	nC
V _{GE(TH)}	Gate to	Emitter Threshold Voltage		I _C = 1.0mA,	$T_{C} = 25^{\circ}C$	1.3	-	2.2	V
				V _{CE} = V _{GE,} See Fig. 10	T _C = 150°C	0.75	-	1.8	V
V_{GEP}	Gate to	Emitter Plateau Voltage		$I_{C} = 10A, V_{CE} =$	= 12V	-	3.0	-	V
vitching	Charao	cteristics							
t _{d(ON)R}	Current	Turn-On Delay Time-Resis	stive	$V_{CE} = 14V, R_L$		-	0.7	4	μs
t _{rR}	Current	Rise Time-Resistive		V _{GE} = 5V, R _G = T _J = 25°C, See	e Fig. 12	-	2.1	7	μs
t _{d(OFF)L}	Current	Turn-Off Delay Time-Induc	tive	V _{CE} = 300V, L		-	4.8	15	μs
t _{fL}		Fall Time-Inductive		V _{GE} = 5V, R _G = 1KΩ T _J = 25°C, See Fig. 12		-	2.8	15	μs
SCIS	Self Cla	nped Inductive Switching		$T_J = 25^{\circ}C, L = 3.0 \text{ mHy}, R_G = 1K\Omega, V_{GE} = 5V, See$ Fig. 1 & 2		-	-	300	mJ
ermal C	haracte	eristics							
$R_{\theta JC}$		Resistance Junction-Case	_	All packages		-	-	1.0	°C/W

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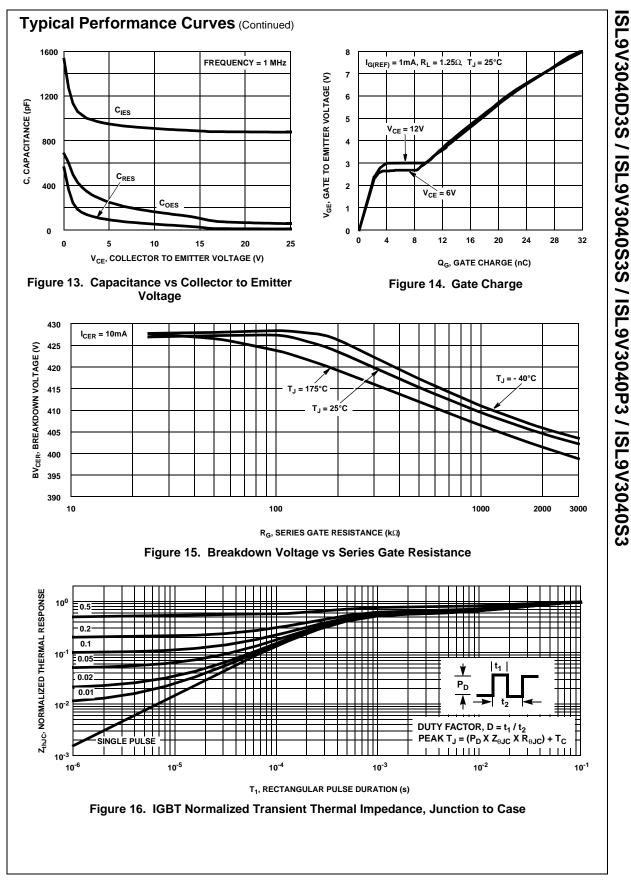


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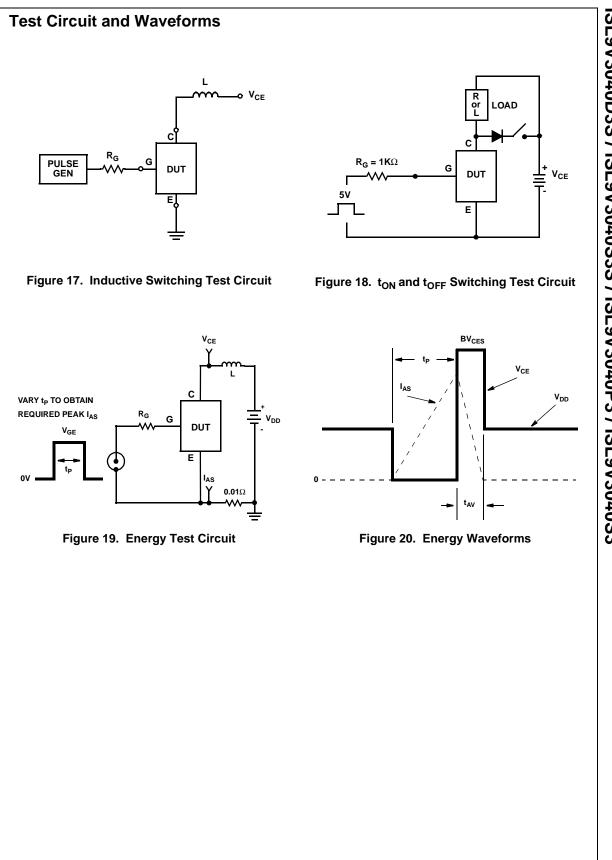
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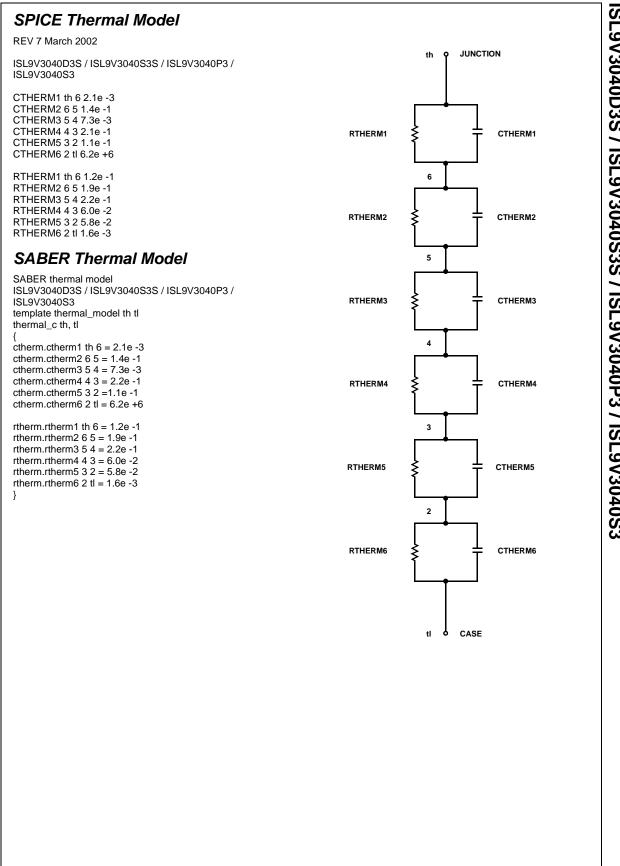


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